

### ■ Features

High Output Power: P<sub>sat</sub>=48.0dBm (Typ.)

• High Gain: G<sub>p</sub>=11.0dB (Typ.)

High Power Added Efficiency: PAE=40% (Typ.)

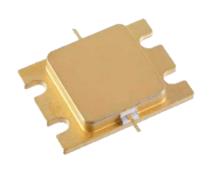
· Broad Band: 8.5 to 9.8GHz

• Impedance Matched Zin/Zout = 50ohm

· Hermetically Sealed Package

# ■ Description

The SGC8598-50A-R is a high power GaN-HEMT that is internally matched for X-band radar bands to provide optimum power and gain in a 50ohm system.



ABSOLUTE MAXIMUM RATING (Case Temperature  $T_c=25 \text{ deg.C}$ )

Item	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	55	V
Gate-Source Voltage	$V_{GS}$	-15	V
Storage Temperature	T <sub>stg</sub>	-55 to +125	deg.C
Channel Temperature	T <sub>ch</sub>	+250	deg.C

RECOMMENDED OPERATING CONDITION

RECOMMENDED OF ERATING CONDITION					
Item	Symbol	Condition	Limit	Unit	
Drain-Source Voltage	$V_{DS}$		<=50	V	
Forward Gate Current	$I_{GF}$	Rg=100ohm	<=4	mA	
Reverse Gate Current	$I_{GR}$	Rg=100ohm	>=-2.2	mA	
Channel Temperature	T <sub>ch</sub>		<+200	deg.C	

**ELECTRICAL CHARACTERISTICS (Case Temperature T<sub>c</sub>=25 deg.C)** 

Item	Symbol Condition	Condition	Limit			Unit
		Condition	Min.	Тур.	Max.	Unit
Pinch-off Voltage	$V_P$	$V_{DS}$ =50V, $I_{DS}$ =3mA	-	-4.5	-	V
Frequency Range	Freq.	$V_{DS}$ =50V-typ. $I_{DS(DC)}$ =0.17A-typ. Pulse Width=100 $\mu$ sec. Duty=10%	8.5	-	9.8	GHz
Output Power at Pin=38dBm	$P_{sat}$		47.0	48.0	-	dBm
Power Gain at Pout=47dBm	G <sub>P</sub>		10.0	11.0	-	dB
Drain Current at Pin=38dBm	I <sub>DSR</sub>		-	2.8	4.1	Α
Power Added Efficiency at Pin=38dBm	PAE		-	40	-	%
Gain Flatness	ΔG		-	1.6	-	dB
Thermal Resistance	R <sub>th</sub>	Channel to Case (P <sub>diss</sub> =50W, CW)	-	2.4	3.0	deg.C/W

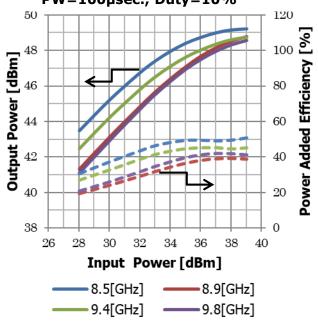
CASE STYLE	IK	
RoHS Compliance	YES	
ESD	Class 2	2000V to <4000V

Note: Based on ANSI/ESDA/JEDEC JS-001-2012(C=100pF, R=1.5kohm)

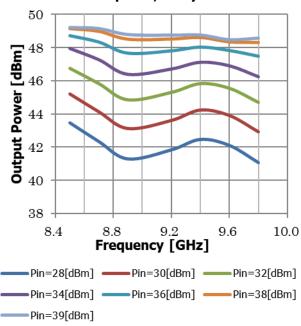


### RF Characteristics

Output Power & Power Added Efficiency vs. Input Power  $V_{DS}$ =50V,  $I_{DS(DC)}$ =0.17A PW=100 $\mu$ sec., Duty=10%

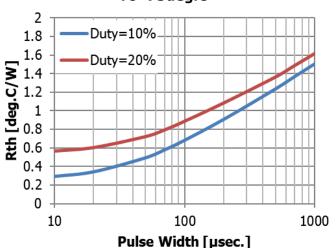


Output Power vs. Frequency  $V_{DS}$ =50V,  $I_{DS(DC)}$ =0.17A PW=100 $\mu$ sec., Duty=10%

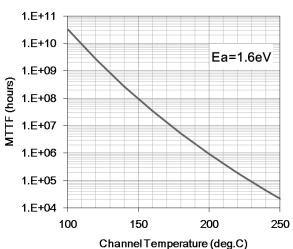


Thermal Characteristics In Pulsed Operation

Rth vs. Pulse Width Tc=75deq.C



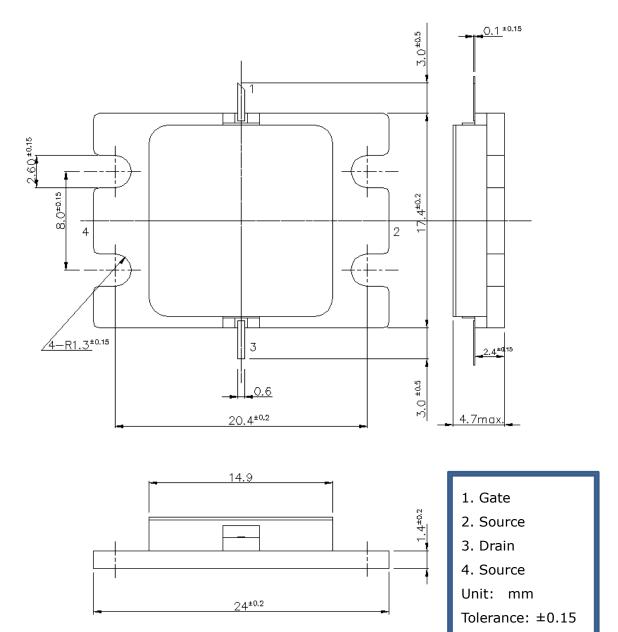
MTTF vs. Tch





# • Package Outline

Case Style : IK





## For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product.
  This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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Edition 1.5 Jul. 2019